Optimum power handling
Low on-state and switching losses
Designed for traction and industrial applications

Rectifier Stud Diode
Type D175-500X-12

Mean on-state current			I_{FAV}		500 A		
Repetitive peak reverse voltage			V_{RRM}		600 ÷ 1200V		
V_{RRM}, V	600	700	800	900	1000	1100	1200
Voltage code	6	7	8	9	10	11	12
T_j, °C	– 60 ÷ 190						

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{FAV}	Average forward current	A	500 659	T_c=142 °C; T_c=120 °C; 180° half-sine wave; 50 Hz	
I_{FRMS}	RMS forward current	A	785	T_c=142 °C; 180° half-sine wave; 50 Hz	
I_{FSM}	Surge forward current	kA	16.0 19.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_R=0 V;
			17.0 20.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_R=0 V;
I^2t	Safety factor	$A^2s\cdot10^3$	1200 1800	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_R=0 V;
			1100 1600	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_R=0 V;
BLOCKING					
V_{RRM}	Repetitive peak reverse voltages	V	600÷1200	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz;	
V_{RSM}	Non-repetitive peak reverse voltages	V	700÷1400	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; single pulse;	
V_R	Reverse continuous voltages	V	0.6·V_{RRM}	T_j=$T_{j\,max}$;	
THERMAL					
T_{stg}	Storage temperature	°C	– 60 ÷ 50		
T_j	Operating junction temperature	°C	– 60 ÷ 190		
MECHANICAL					
F	Mounting force	kN	1.5 ÷ 2.5		
a	Acceleration	m/s^2	100		

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V_{FM}	Peak forward voltage, max	V	1.40	T_j=25 °C; I_{FM}=1570 A
$V_{F(TO)}$	Forward threshold voltage, max	V	0.809	T_j=$T_{j\ max}$;
r_T	Forward slope resistance, max	mΩ	0.376	0.5 π I_{FAV} < I_T < 1.5 π I_{FAV}
BLOCKING				
I_{RRM}	Repetitive peak reverse current, max	mA	40	T_j=$T_{j\ max}$; V_R=V_{RRM}
SWITCHING				
Q_{rr}	Total recovered charge, max	μC	830	T_j=$T_{j\ max}$; I_{TM}=500 A ; di_R/dt=-10 A/μs ; V_R=100 V;
t_{rr}	Reverse recovery time, max	μs	15	
I_{rrM}	Peak reverse recovery current, max	A	110	
THERMAL				
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.075	Direct current
MECHANICAL				
w	Weight, max	g	500	
D_s	Surface creepage distance	mm (inch)	12.4 (4.882)	
D_a	Air strike distance	mm (inch)	12.4 (4.882)	

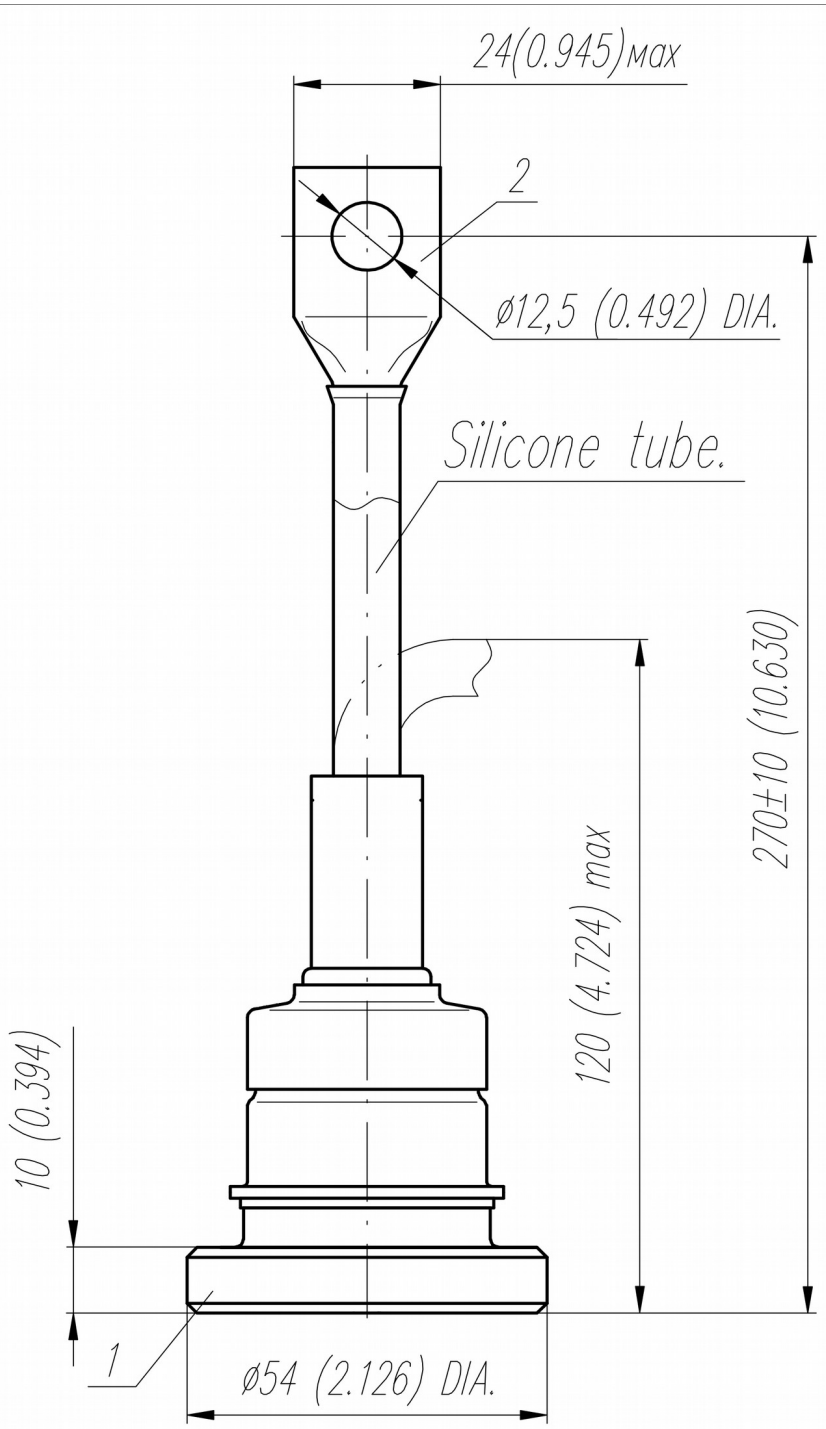
PART NUMBERING GUIDE

D	175	500	X	12	N
1	2	3	4	5	6

1. D — Rectifier Diode
2. Design version
3. Average forward current, A
4. Polarity: X – Cathode to Stud; Anode to Stud – no symbol
5. Voltage code
6. Ambient conditions: N – normal; T – tropical

OVERALL DIMENSIONS

Package type: D.SB3



Polarity		Example of code designation	Reference designation	Colors	
				Anode	Cathode
Reverse	Cathode to stud	D175-500**X**-12		Black tube	-

All dimensions in millimeters (inches)

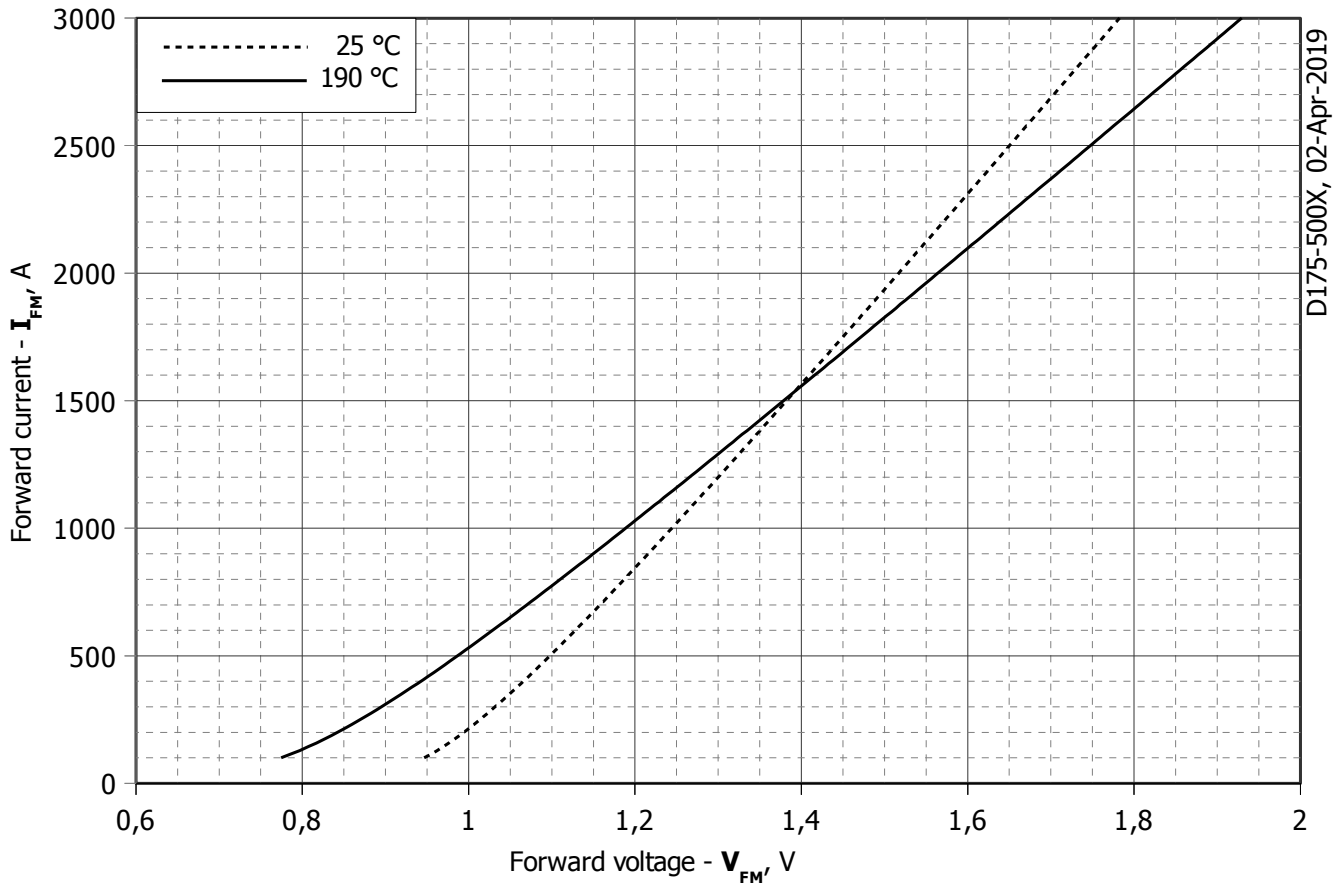


Fig 1 – Forward characteristics of Limit device

$$V_F = A + B \cdot i_F + C \cdot \ln(i_F + 1) + D \cdot \sqrt{i_F}$$

	Coefficients for max curves	
	T_j = 25°C	$T_j = T_{j\,max}$
A	0,75818000	0,49236000
B	0,00026115	0,00036297
C	0,03751000	0,05786700
D	-0,00108460	-0,00210100

Forward characteristic model (see Fig. 1).

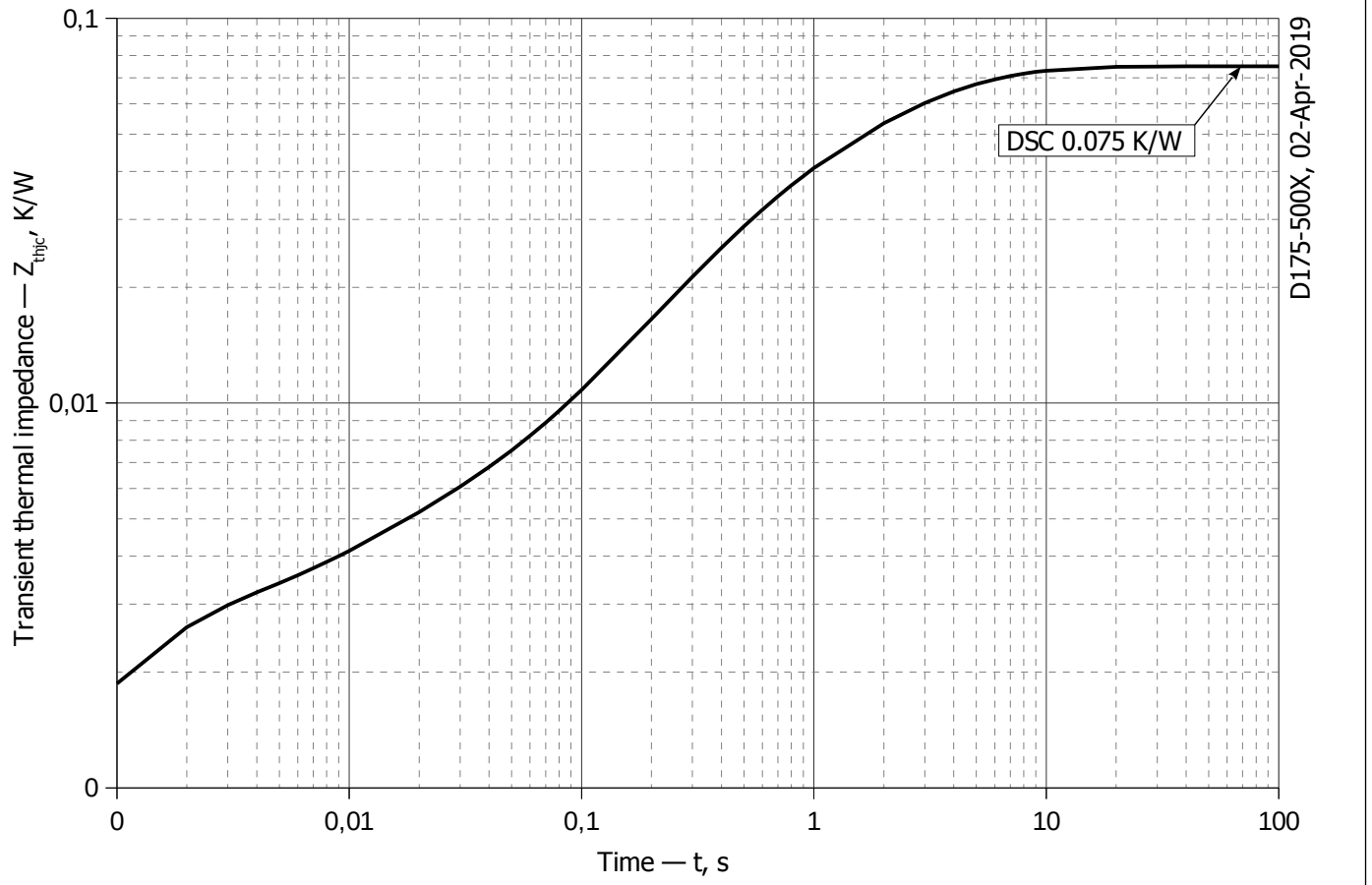


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^{n} R_i \left(1 - e^{-\frac{t}{\tau_i}}\right)$$

Where ***i*** = 1 to ***n***, ***n*** is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t.

R_i = Amplitude of p_{th} term.

τ_i = Time constatnt of r_{th} term.

DC

i	1	2	3	4	5	6
R_i, K/W	0.013357	0.02733	0.01495	0.001445	0.002488	0.01543
τ_i, s	4.627	2.249	0.3406	0.01043	0.0009112	0.9081

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

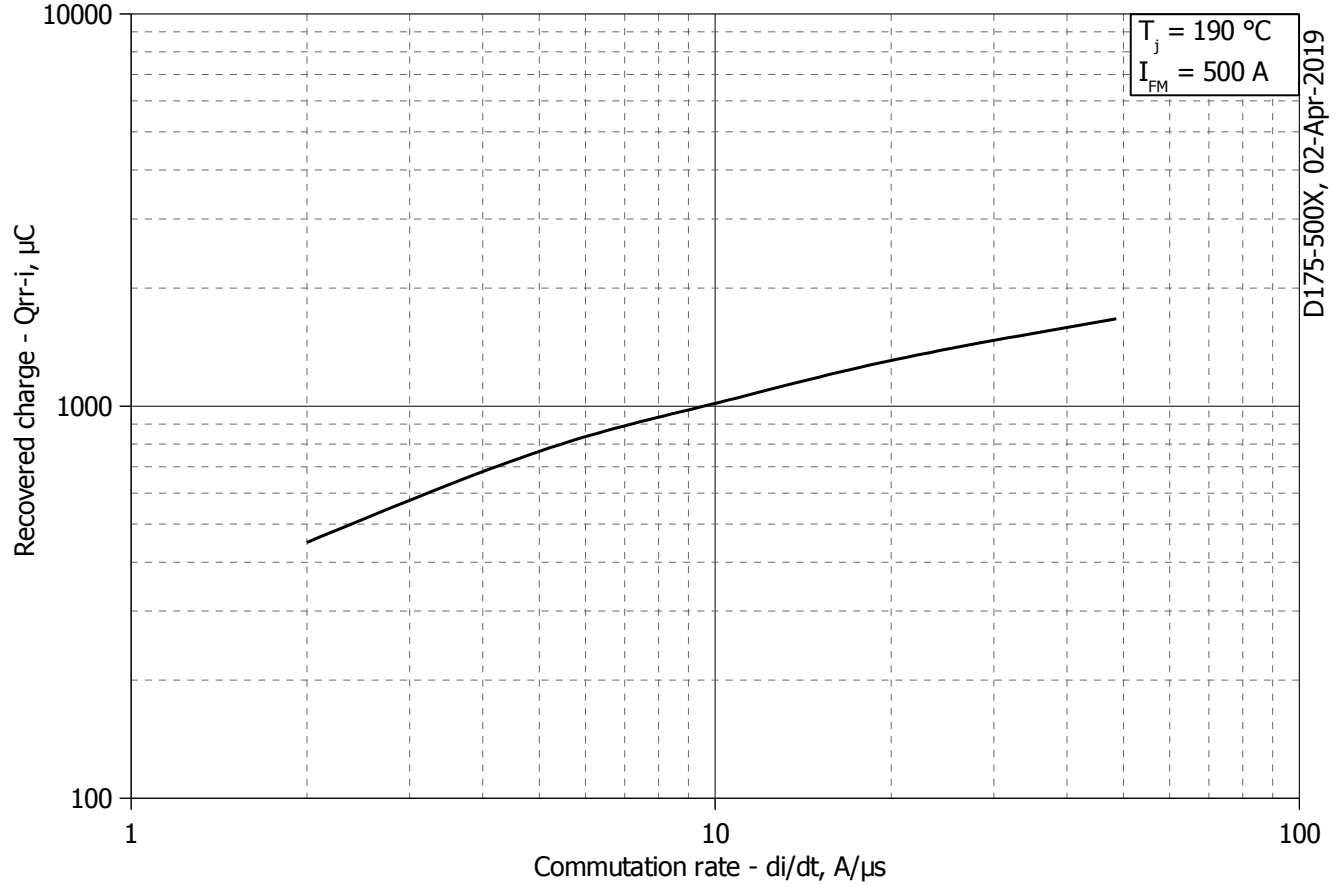


Fig 3 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

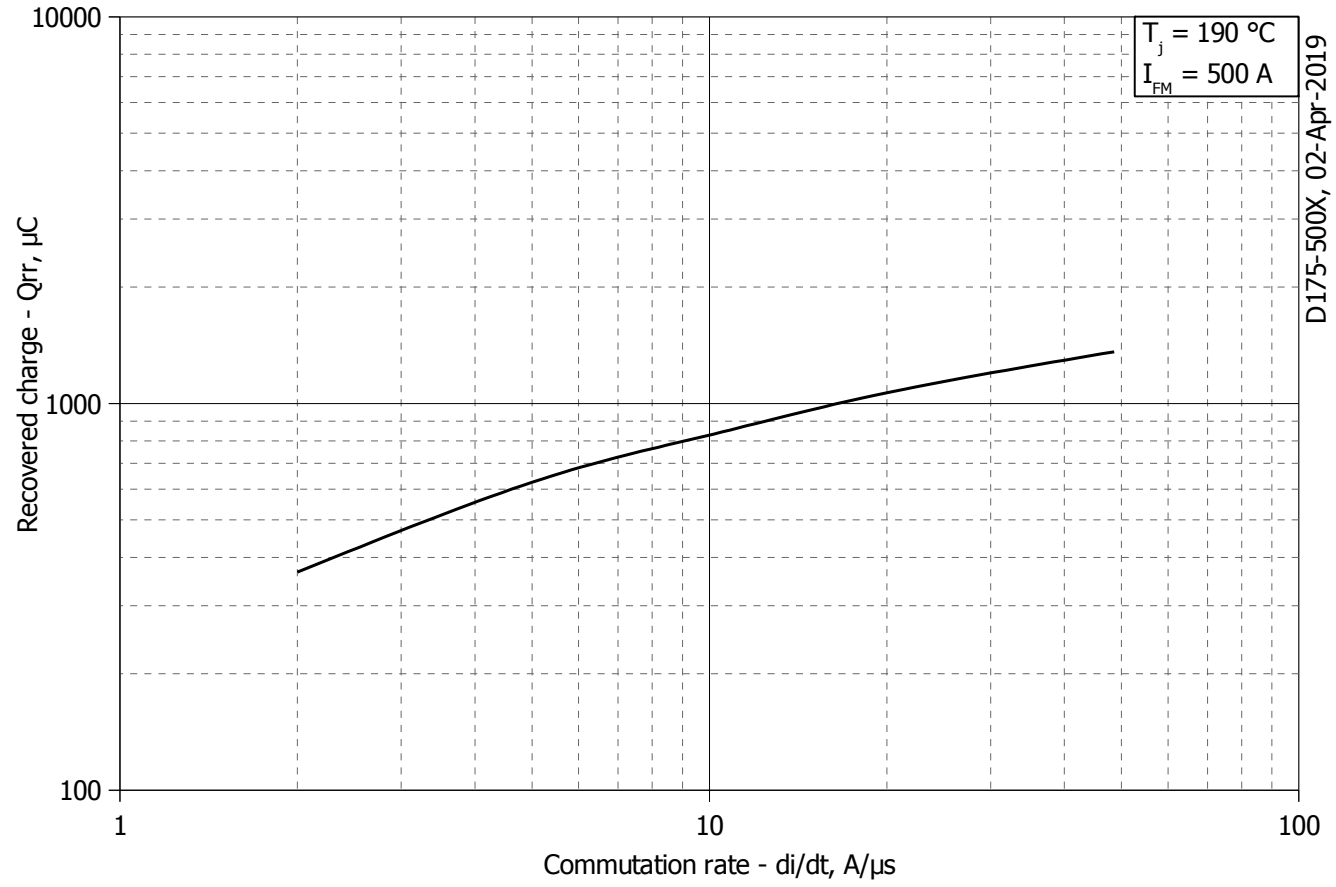


Fig 4 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

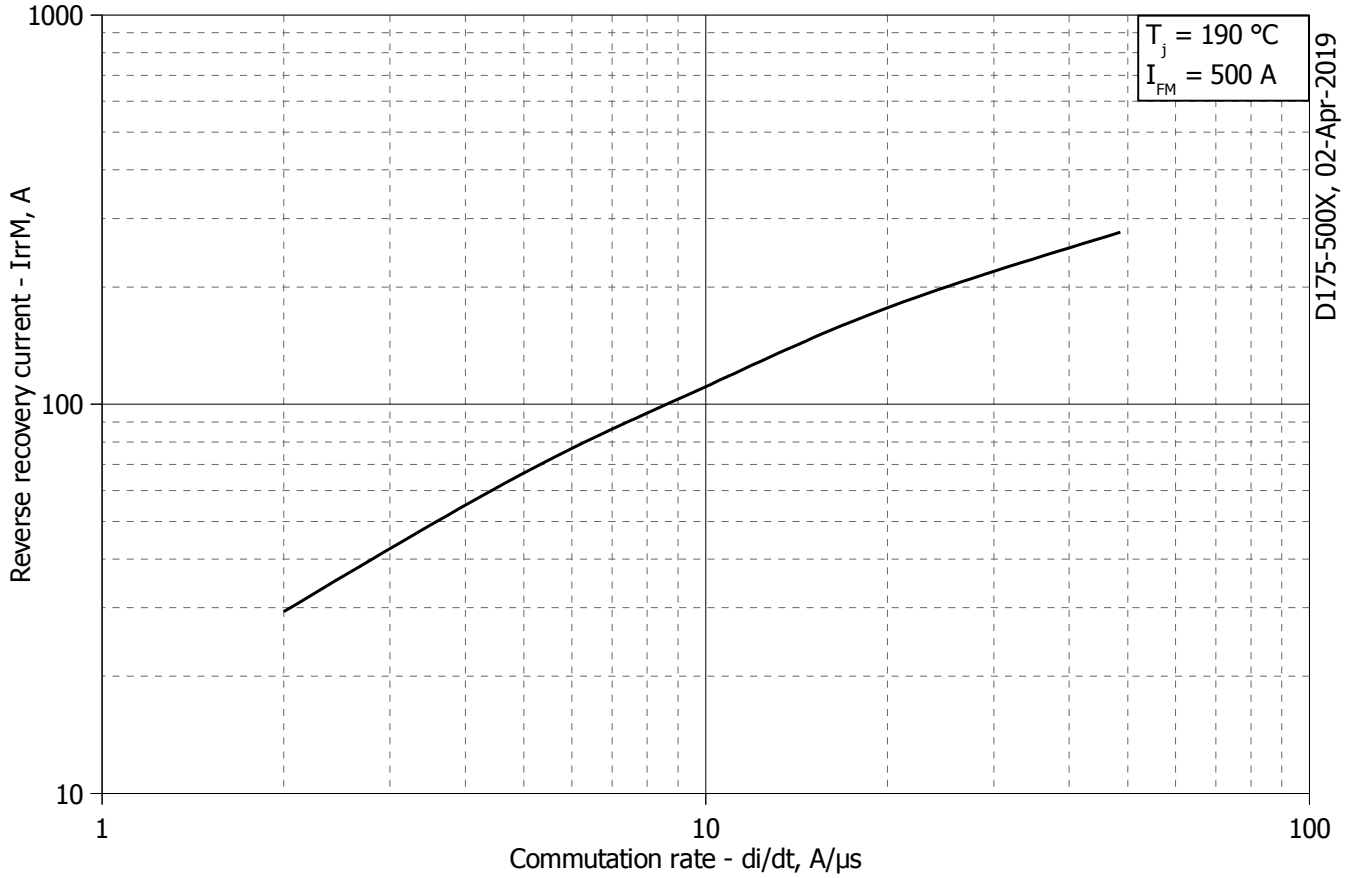


Fig 5 – Maximum reverse recovery current I_{rrM} vs. commutation rate di_R/dt

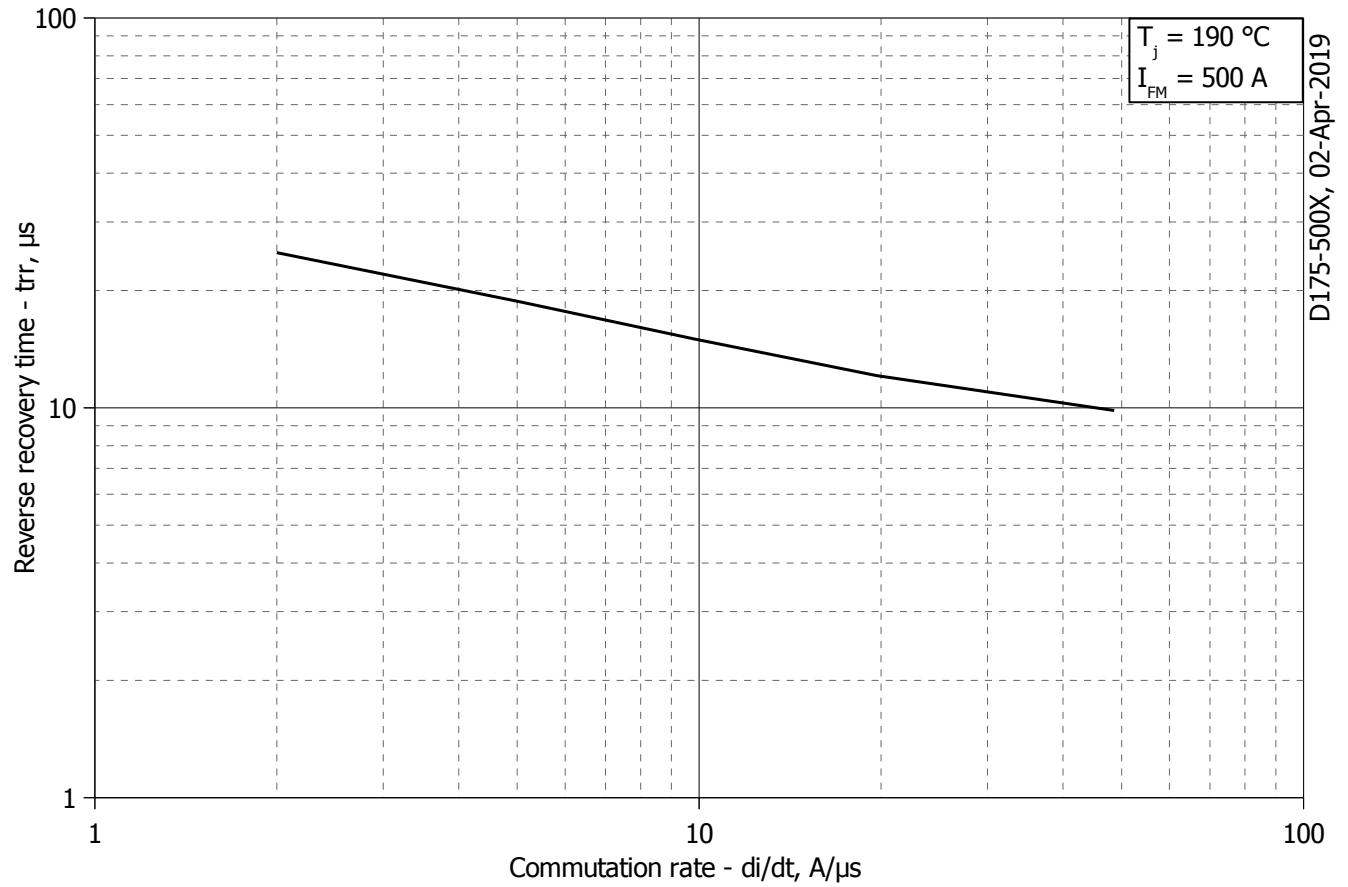


Fig 6 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)

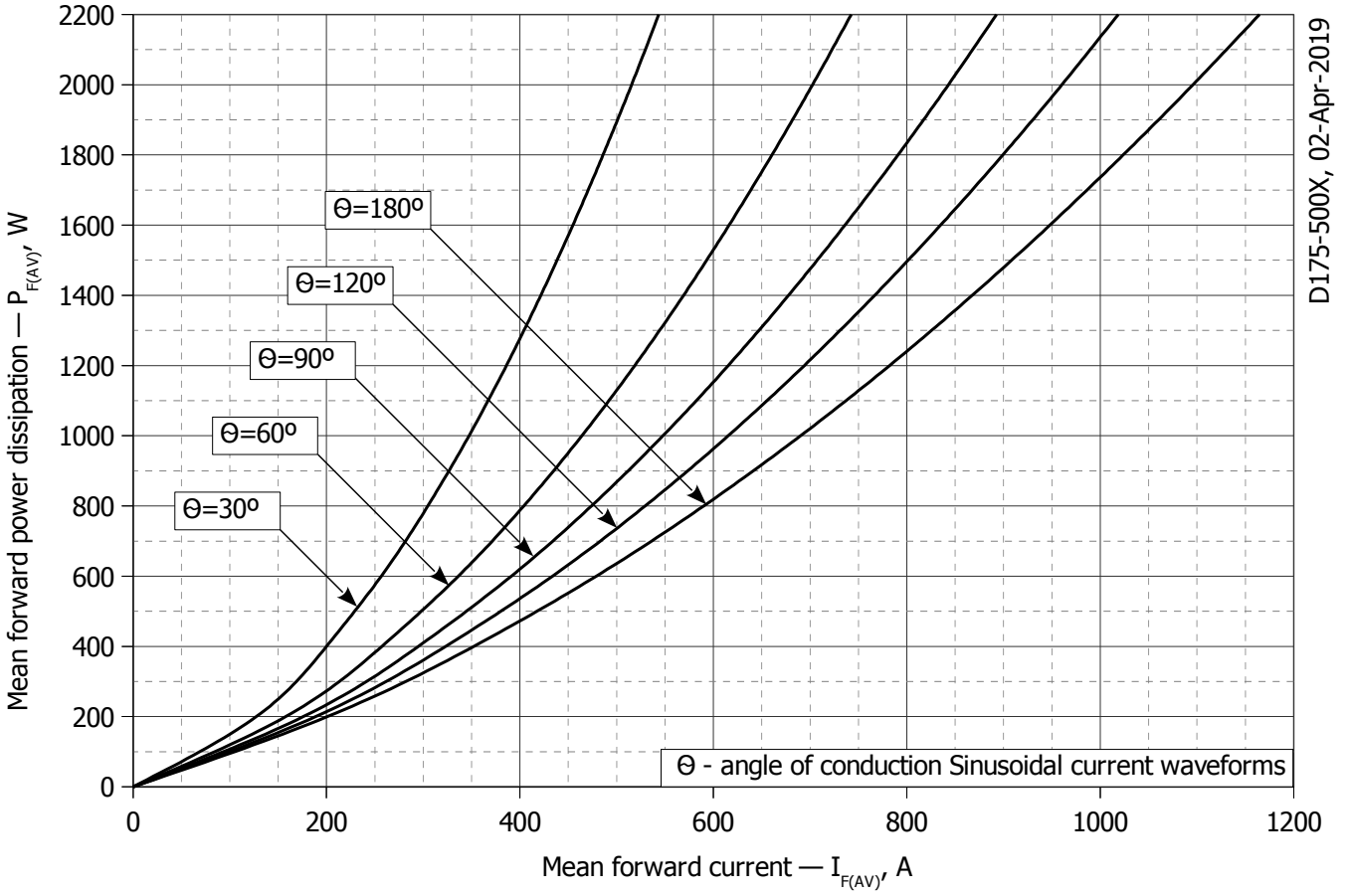


Fig. 7 - Mean forward power dissipation P_{FAV} vs. mean forward current I_{FAV} for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

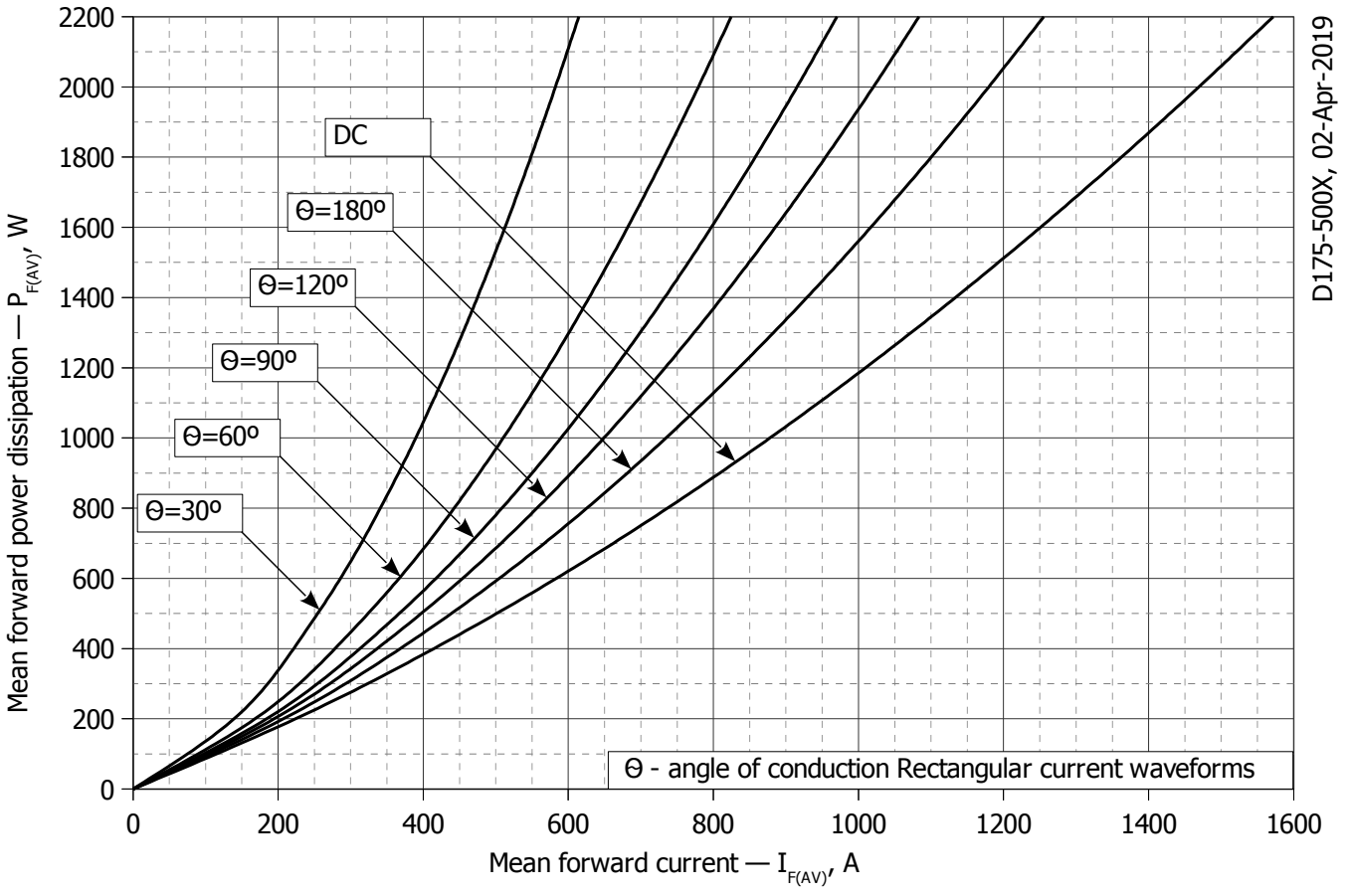


Fig. 8 – Mean forward power dissipation P_{FAV} vs. mean forward current I_{FAV} for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

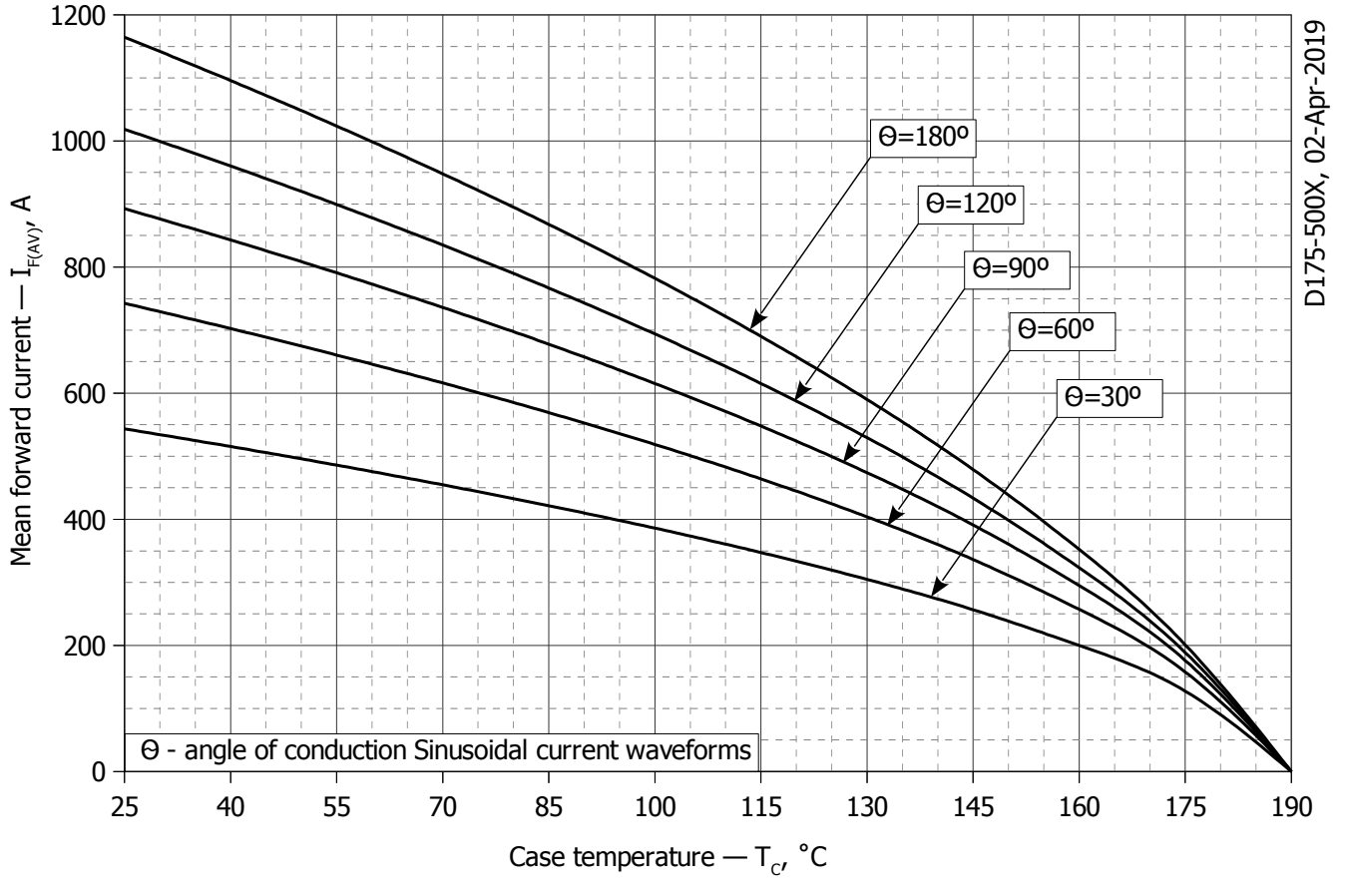


Fig. 9 – Mean forward current I_{FAV} vs. case temperature T_C for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

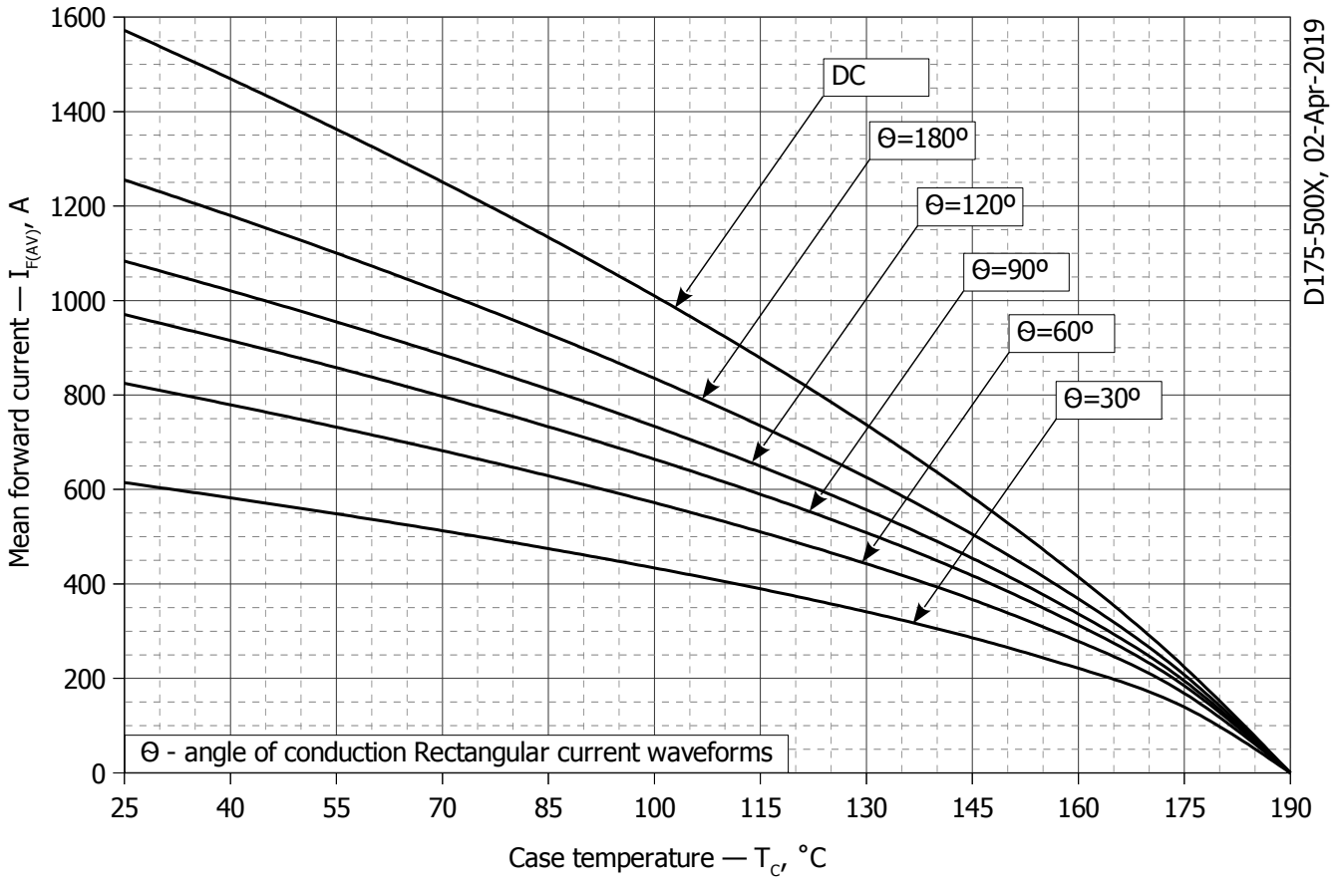


Fig. 10 - Mean forward current I_{FAV} vs. case temperature T_C for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

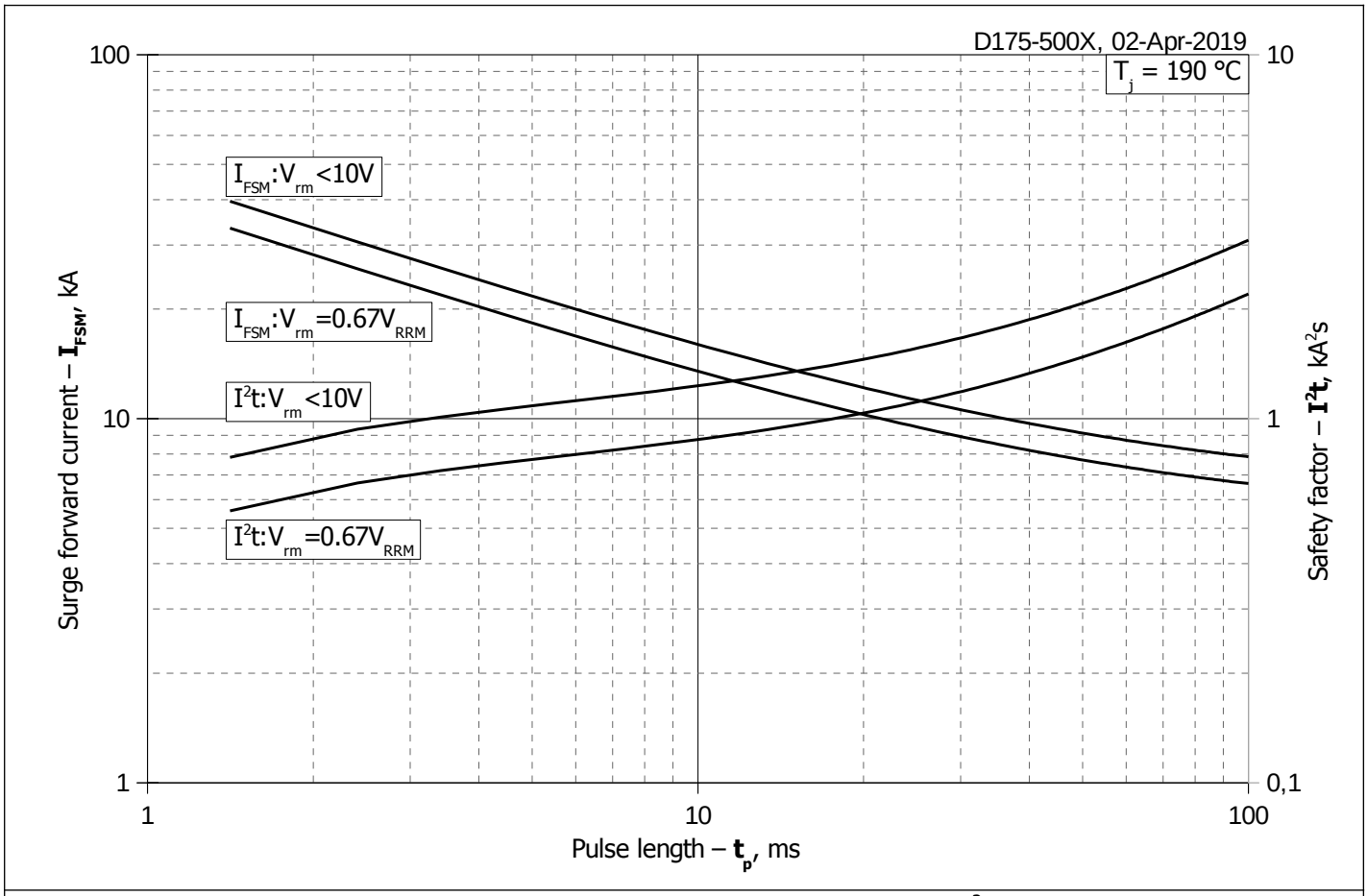


Fig. 11 – Maximum surge forward current I_{FSM} and safety factor I^2t vs. pulse length t_p

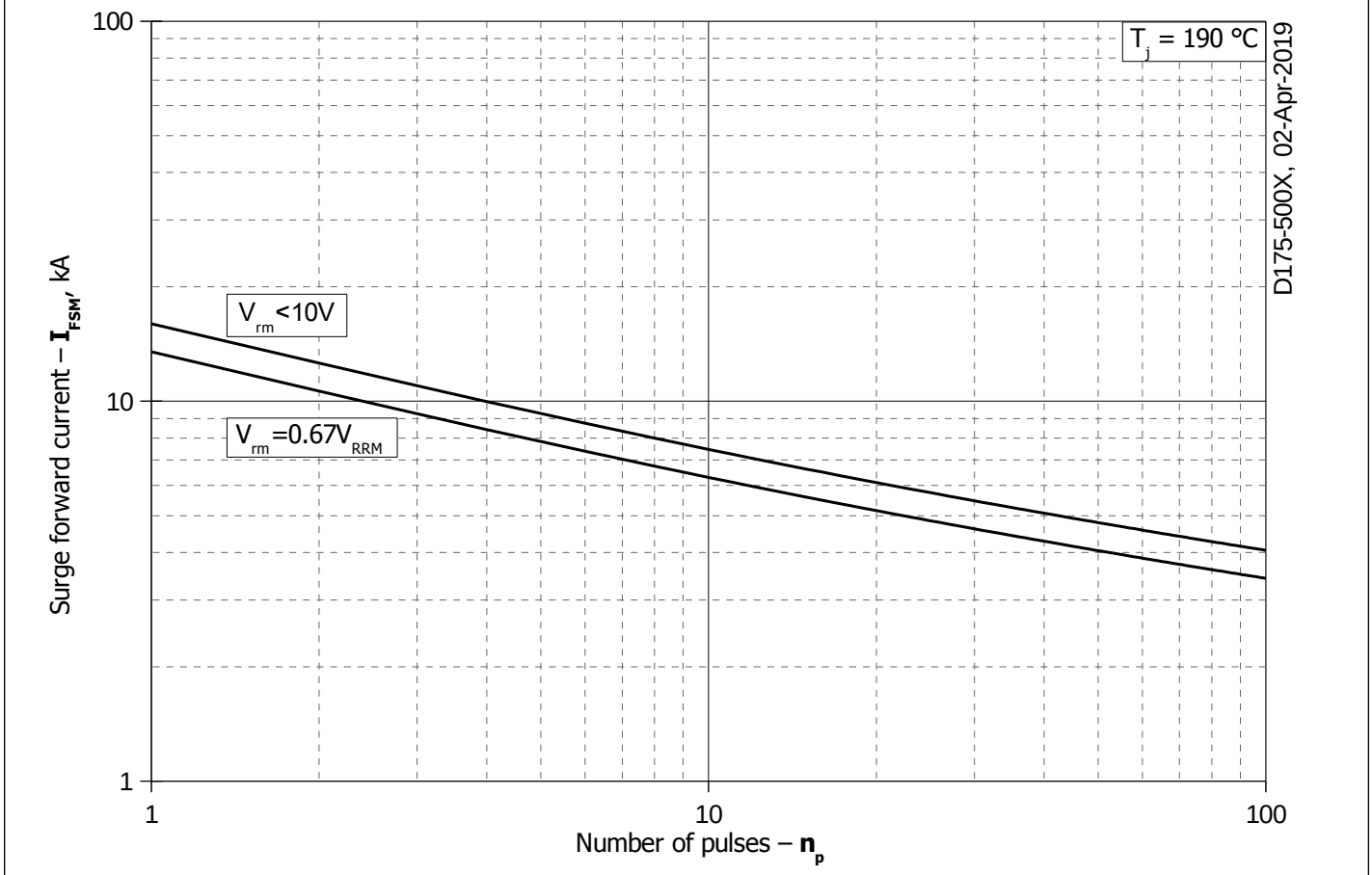


Fig. 12 - Maximum surge forward current I_{FSM} vs. number of pulses n_p